

AMENDMENTS TO THE SPECIFICATION

Applicant agrees with the Examiner and, therefore, please amend the title as follows:

~~BOLSTER PLATE BOW COMPENSATION~~

A METHOD OF ATTACHING AN INTEGRATED CIRCUIT TO A CHIP MOUNTING
RECEPTACLE IN A PCB WITH A BOLSTER PLATE

Also, please amend the following section title as follows:

~~BACKGROUND~~ BACKGROUND OF THE INVENTION